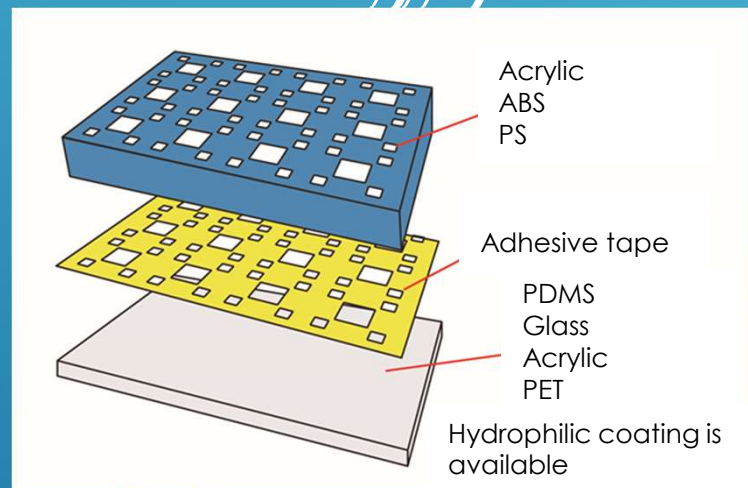
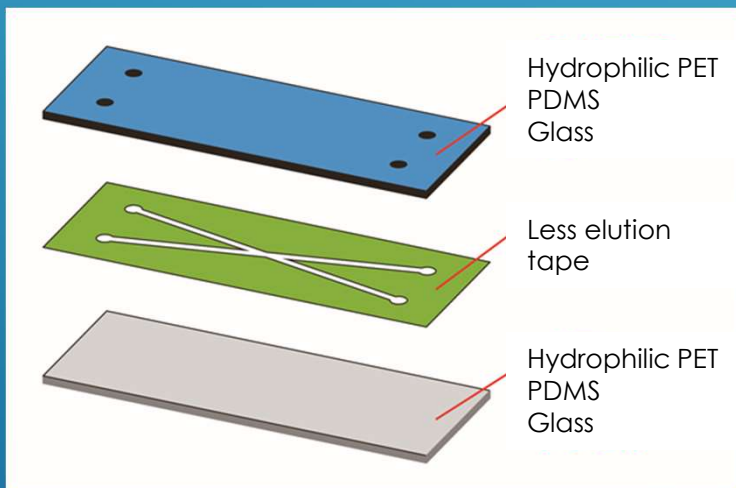
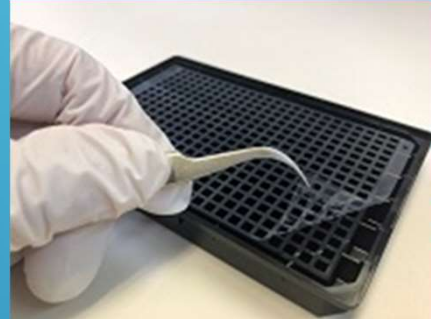
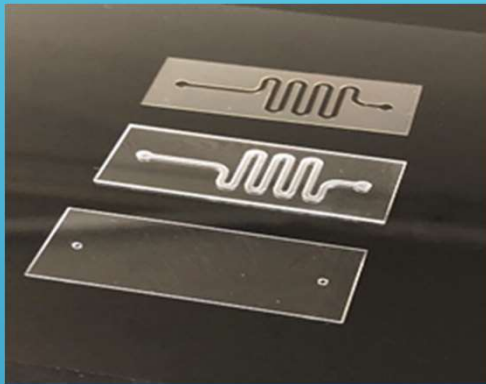


Microfluidic chip and Micro plate

by laser micro processing for channels & holes
and bonded plates by less elution tape



Our advantages are

- 1. Most materials are available to bond together**
- 2. No masking cost because of laser processing**
- 3. Reasonable cost because of tape bonding**



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